506134223 07/01/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEUNG EUN CHOI	06/11/2020

RECEIVING PARTY DATA

Name:	SALPHA THERAPEUTICS INC.
Street Address:	407, 4TH FLOOR, 31, SEOCHOJUNGANG-RO 18-GIL, SEOCHO-GU
City:	SEOUL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	06634

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16883369

CORRESPONDENCE DATA

Fax Number: (202)739-3001

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2027393000

Email: patents@morganlewis.com, anne.sayles@morganlewis.com

Correspondent Name: JANICE H. LOGAN

Address Line 1: 1111 PENNSYLVANIA AVE NW Address Line 4: WASHINGTON, D.C. 20004

ATTORNEY DOCKET NUMBER:	104604-5013-01
NAME OF SUBMITTER:	JANICE LOGAN
SIGNATURE:	/Janice Logan/
DATE SIGNED:	07/01/2020

Total Attachments: 1

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PATENT 506134223 REEL: 053098 FRAME: 0895

ASSIGNMENT

WHEREAS I, the below named inventor, (hereinafter referred to as "Assignor"), have made an invention entitled:

DIGITAL APPARATUS AND APPLICATION FOR TREATING MYOPIA

filed as U.S. Patent Application No. 16/883,369 on May 26, 2020;

WHEREAS Salpha Therapeutics Inc. whose post office address 407, 4th floor, 31, Seochojungang-ro 18-gil, Seocho-gu Seoul 06634 Republic of Korea (hereinafter referred to as "Assignee"), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the applications of patent on this invention and the Letters Patent to be issued upon these applications:

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee has hereby acknowledged, I, as assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns. MY entire right, title, and interest in and to this invention and all United States applications, and all divisions, and continuations thereof, and all United States Letters Patents which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and divisionals and reissues thereof; and I hereby authorize and request the Director of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY coveriant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I have hereunto set my hands.

Full Name of Assignor	Seung Eun Chai
Address	407, 4th floor, 31, Seochojungang-ro 18-gil, Seocho-gu, Seoul 06634 Republic of Korea
Signature	Seure Em Chris
Date	Tue 11 2020

Morgan, Lewis & Bockius LLP